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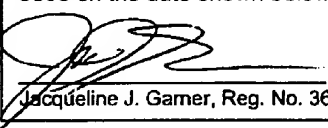
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Celii et al. Art Unit: 1765
Serial No.: 09/599,718 Examiner: Mackey, T.
Filing Date: 06/22/00 Docket No.: T1-29276
Title: PROCESS FLOW FOR DUAL DAMASCENE INTERCONNECT
STRUCTURES

OFFICIAL

CERTIFICATION OF FACSIMILE TRANSMISSION

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Jacqueline J. Garner, Reg. No. 36,144December 4, 2003
Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET	<input checked="" type="checkbox"/> AMENDMENT (9 Pages)
<input type="checkbox"/> NEW APPLICATION	<input checked="" type="checkbox"/> EOT (3 Pages)
<input type="checkbox"/> DECLARATION (# Pages)	<input type="checkbox"/> NOTICE OF APPEAL (# Pages)
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NAME OF INVENTOR(S): Celii		RECEIPT DATE & SERIAL NO.: Serial No.: 09/599,718 Filing Date: 06/22/2000	
TITLE OF INVENTION: Process Flow for Dual Damascene Interconnect			
FILE NO.: T1-29276	DEPOSIT ACCT. NO.: 20-0668		
FAXED: December 4, 2003 DUE: 9/04/2003 ATTY/SEC'Y: JLG			

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Appl. No. : 09/599,718 Confirmation No. 8761
Applicant : Francis G. Celii et al.
Filed : 06/22/2000
TC/A.U. : 1765
Examiner : Terrence M. Mackey

Docket No. : TI-29276
Customer No. : 23494

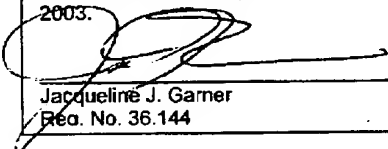
Title : PROCESS FLOW FOR DUAL DAMESCENE
INTERCONNECT STRUCTURES

AMENDMENT UNDER 37 CFR 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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Jacqueline J. Garner
Reg. No. 36.144

In response to the Office action of 06/04/2003, please amend the above-identified application as follows:

There are no **Amendments to the specification.**

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

There are no **Amendments to the Drawings.**

Remarks/Arguments begin on page 5 of this paper.